6-1971798-2 ACTIVE

GRACE INERTIA 2.5

TE Internal #: 6-1971798-2

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder,

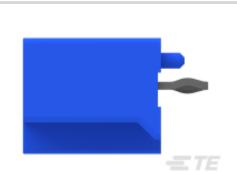
GRACE INERTIA 2.5

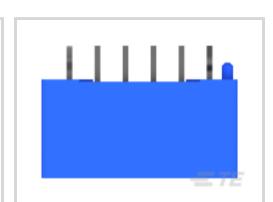
View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Glow Wire Sig GRACE INERTIA Header











Connector System: Wire-to-Board

Number of Positions: 6
Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]
PCB Mount Orientation: Vertical

All Glow Wire Sig GRACE INERTIA Header (39)

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	6
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	50 VAC

Connector & Keying Code

Primary Product Color



l+1 800 522 6752	09	/15/2023 07
PCB Mount Retention	With	
PCB Mount Alignment	With	
Mating Alignment	With	
Connector Mounting Type	Board Mount	
Mating Retention Type	Latch	
PCB Mount Retention Type	Kinked	
Mating Retention	With	
Mating Alignment Type	Keyed	
PCB Mount Alignment Type	Locating Posts	
Mechanical Attachment		
Termination Method to Printed Circuit Board	Through Hole - Solder	
Termination Post & Tail Length	3 mm[.118 in]	
Rectangular Termination Post & Tail Width	.5 mm[.02 in]	
Rectangular Termination Post & Tail Thickness	.46 mm[.018 in]	
Termination Features		
Contact Current Rating (Max)	3 A	
Contact Type	Tab	
Contact Mating Area Plating Material	Tin	
Contact Base Material	Brass	
PCB Contact Termination Area Plating Material	Tin	
Contact Underplating Material	Nickel	
Contact Mating Area Plating Material Finish	Matte	
Contact Shape & Form	Square	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Mating Area Plating Material Thickness	1 μm[39.37 μin]	
Contact Underplating Material Thickness	1.27 μm[50 μin]	
Mating Tab Width	.5 mm[.02 in]	
Contact Layout	Inline	
PCB Contact Termination Area Plating Material Thickness	1 μm[39.37 μin]	
Mating Square Post Dimension	.5 mm[.02 in]	

В

Blue



Housing Features

Housing Material	Nylon
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Connector Length	17.5 mm[.68 in]
Connector Height	8.8 mm[.34 in]
Connector Width	7.38 mm[.29 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-30 - 105 °C[-22 - 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Glow Wire Rating	Glow Wire
Agency/Standard	UL
Approved Standards	UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	750

Product Compliance

Packaging Type

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not reviewed for solder process capability

Bag, Box



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts





Customers Also Bought

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.5















YLW D1.0





TE Part #2368182-4
RA SMC2.5 Potting header_4P

TE Part #2368182-9 RA SMC2.5 Potting header_9P

Documents

Product Drawings

NEW GI CONN2.5 HDR ASMBLY 6P BLU D1.0

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_6-1971798-2_E_c-6-1971798-2-e.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_6-1971798-2_E_c-6-1971798-2-e.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_6-1971798-2_E_c-6-1971798-2-e.3d_stp.zip

English

By downloading the CAD file I accept and agree to the $\pmb{\mathsf{Terms}}$ and $\pmb{\mathsf{Conditions}}$ of use.

Datasheets & Catalog Pages

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.5



5-1773465-3-GI2.5Flyer

English

7-1773465-8-GI2.5-ChineseFlyer

Product Specifications

Application Specification

English